

Xencor™ PPA LGF-1950 HS

polyphthalamide

Xencor™ PPA LGF-1950 HS is 50% long glass fiber reinforced, easy-flowing PPA which can be processed on most injection molding machines.

This material achieves extremely high mechanical and thermal properties, in combination with ease of processing and fast cycle times. It exhibits high strength, stiffness and impact strength at high

temperatures; excellent creep and fatigue resistance; isotropic mechanical properties and reduced anisotropic shrinkage; high shear strength and high burst pressure; and an excellent surface finish.

- Black: Xencor™ PPA LGF-1950 HS BK 545-9
- Natural: Xencor™ PPA LGF-1950 HS NT-9

General					
Material Status	 Commercial: Active 				
Availability	 Africa & Middle East Asia Pacific Europe	 Latin America North America			
Filler / Reinforcement	 Long Glass Fiber, 50% Filler b 	ong Glass Fiber, 50% Filler by Weight			
Features	Creep ResistantElectrically InsulatingFatigue ResistantHigh Impact Resistance	High Temperature StiffnessLow CLTELow ShrinkageLow Warpage			
Uses	Aircraft ApplicationsAutomotive Applications	Consumer ApplicationsIndustrial Applications			
RoHS Compliance	• RoHS Compliant				
Appearance	• Black	Natural Color			
Forms	• Pellets				
Processing Method	Compression MoldingInjection Molding	Overmolding			
Physical	Dry	Conditioned Unit	Test method		
Density	1.61	g/cm³	ISO 1183		
Molding Shrinkage	0.25	%	Internal Method		
Water Absorption (Equilibrium, 23°C, 50% RH)	0.80	%	ISO 62		

Mechanical	Dry	Conditioned U	nit	Test method	
Tensile Modulus				ISO 527-1	
23°C	18500	18300 M	1Pa		
90°C	16500	N	1 Ра		
120°C	10500	N	ИРа		
Tensile Stress				ISO 527-2	
Break, 23°C	275	260 M	1 Ра		
Break, 90°C	210	N	1 Ра		
Break, 120°C	135	N	1 Ра		
Tensile Strain (Break)	2.0	2.0 %	,)	ISO 527-2	
Flexural Modulus (23°C)	17500	N	1 Ра	ISO 178	
Flexural Stress	410	N	1 Ра	ISO 178	
Impact	Dry	Conditioned U	Init	Test method	
Charpy Notched Impact Strength				ISO 179	
-30°C	32	k	J/m²		
23°C	32	32 k	J/m²		
Charpy Unnotched Impact Strength				ISO 179	
-30°C	95	k	J/m²		
23°C	95	85 k	J/m²		
Thermal	Dry	Conditioned U	Init	Test method	
Deflection Temperature Under Load	,				
0.45 MPa, Unannealed	300	°(С	ISO 75-2/B	
1.8 MPa, Unannealed	285	°(С	ISO 75-2/A	
Thermal Conductivity	0.35	W	V/m/K	ISO 22007	
Coefficient of Linear Thermal Expansion	2.0E-5	c	m/cm/°C	ISO 7991	
Electrical	Dry	Conditioned U	Init	Test method	
Surface Resistivity	1.0E+13	o	hms	ASTM D257	
Dielectric Strength	35	k	V/mm	IEC 60243-1	
Comparative Tracking Index	600	V	1	IEC 60112	
Injection		Dry Unit			
Drying Temperature	120 °C				
Drying Time	4.0 to 8.0 hr				
Suggested Max Moisture	0.030 to 0.060 %				
Suggested Max Regrind	20 %				
Rear Temperature	330 to 340 °C				
Middle Temperature	340 °C				
Front Temperature	340 °C				
Nozzle Temperature	335 to 345 °C				
Processing (Melt) Temp	< 345 °C				
Mold Temperature		135 to 160 °C			
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Injection Notes

Pre-Drying -- Since polyamides are hygroscopic materials as well as sensitive to moisture during processing, this product should always be pre-dried.

Regrind -- Regrind of highly filled thermoplastic materials, such as this material, should only be recycled with special care. The regrind content must never exceed 20% and only regrind of optimum quality should be used. In any case, part properties should be checked.

Notes

Typical properties: these are not to be construed as specifications.

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